

## GENERAL DESCRIPTION

OB3398Ex is a primary side regulation off-line LED lighting power switch which can achieve accurate LED current. It significantly simplifies LED lighting system design by eliminating the secondary side feedback circuitry. Proprietary Constant Voltage (CV) and Constant Current (CC) control is integrated as shown in the figure below.

The LED current (CC control) can be adjusted externally by the resistor Rs at CS pin.

OB3398Ex offers comprehensive protection coverage with auto-recovery features including Cycle-by-Cycle current limiting, VDD clamp and UVLO.

OB3398Ex is offered in DIP8/SOP7 package.

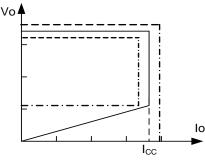


Fig.1. Typical CC/CV Curve

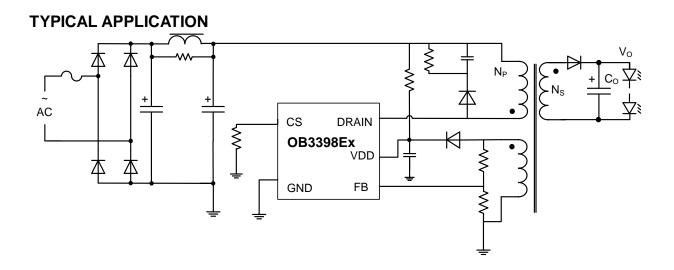
# FEATURES

- High Precise Constant Current Regulation at Universal AC input
- Primary-side Sensing and Regulation Without TL431 and Opto-coupler
- HV MOSFET integrated
- Floating PSR control scheme with two transformer windings
- Adjustable Constant Current and Output Power Setting
- Built-in Primary winding inductance compensation
- Built-in Leading Edge Blanking (LEB)
- Cycle-by-Cycle Current Limiting
- VDD Under Voltage Lockout with Hysteresis (UVLO)
- Latched over temperature protection (OTP)
- VDD Clamp

## APPLICATIONS

Low Power AC/DC offline SMPS for

LED applications

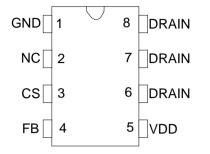




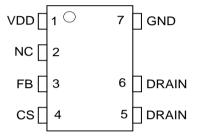
## **GENERAL INFORMATION**

### **Pin Configuration**

The pin map is shown as below for DIP8.



The pin map is shown as below for SOP7.



### **Ordering Information**

Part Number	Description			
OB3398ENJP	SOP7, Halogen-free, Tube			
OB3398ENJPA	SOP7, Halogen-free, T&R			
OB3398EPJP-H	SOP7, Halogen-free, Tube			
OB3398EPJPA-H	SOP7, Halogen-free, T&R			
OB3398ETJP-H	SOP7, Halogen-free, Tube			
OB3398ETJPA-H	SOP7, Halogen-free, T&R			
OB3398EPAP-H	DIP8, Halogen-free, Tube			
OB3398ETAP-H	DIP8, Halogen-free, Tube			
OB3398EVAP-H	DIP8, Halogen-free, Tube			

### Package Dissipation Rating

Package	RθJA (°C/W)
DIP8	75
SOP7	95

#### **Absolute Maximum Ratings**

Parameter	Value	
	value	
Drain Voltage	-0.3 to BVdss	
VDD Voltage	-0.3 to V <sub>DD</sub> _clamp	
CS Input Voltage	-0.3 to 7V	
FB Input Voltage	-0.3 to 7V	
Min/Max Operating Junction	-40 to 150 ℃	
Temperature T <sub>J</sub>		
Operating Ambient	-40 to 85 ℃	
Temperature T <sub>A</sub>	-40 10 65 0	
Min/Max Storage	-55 to 150 ℃	
Temperature T <sub>stg</sub>	-55 10 150 C	
Lead Temperature	<b>260 °</b> ⊂	
(Soldering, 10secs)	<b>260</b> °C	

**Note:** Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability.

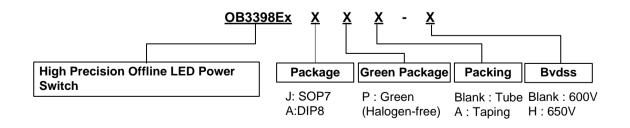
#### **Output Power Table**

Product	90Vac~264Vac Input	220Vac±20% Input
OB3398ENJP	7.7W	12.4W
OB3398EPJP-H	13.9W	21W
OB3398ETJP-H	15W	24W
OB3398EPAP-H	15.8W	28W
OB3398ETAP-H	20.6W	30.2W
OB3398EVAP-H	23.7W	33.8W

**Note:** Maximum practical continuous power in an open frame design with sufficient drain pattern as a heat sink, at  $50^{\circ}$ C ambient and  $60^{\circ}$ C temperature rise. Higher output power is possible with extra added heat sink, air circulation and decrease output current to reduce thermal resistance

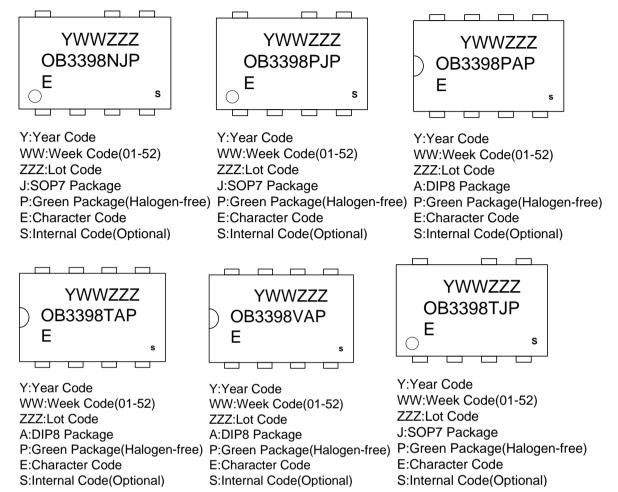
#### **Recommended Operating Condition**

Symbol	Parameter	Range
VDD	VDD Supply Voltage	12 to 25 V





# **Marking Information**



# **TERMINAL ASSIGNMENTS for OB3398EPAP**

Pin Num	Pin Name	I/O	Description
1	GND	Р	Ground
2	NC		No connect
3	CS	Ι	Current sense input.
4	FB	I	Connected to resistor divider from primary winding or auxiliary winding to reflect output voltage.
5	VDD	Р	Power Supply
6,7,8	Drain	0	Drain of internal power MOSFET

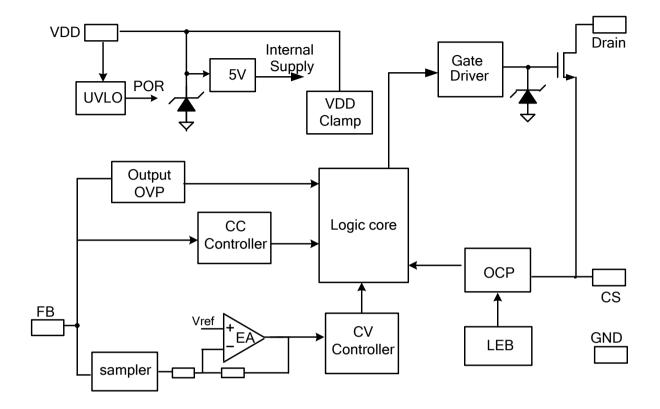
### TERMINAL ASSIGNMENTS for OB3398ENJP& OB3398EPJP& OB3398ETJP

Pin Num	Pin Name	I/O	Description
1	VDD	Р	Power Supply
2	NC		No connect
3	FB	I	Connected to resistor divider from primary winding or auxiliary winding to reflect output voltage.
4	CS	Ι	Current sense input.
5,6	Drain	0	Drain of internal power MOSFET
7	GND	Р	Ground

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# **BLOCK DIAGRAM**





# **ELECTRICAL CHARACTERISTICS**

### $(TA = 25^{\circ}C, VDD = 16V, if not otherwise noted)$

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit	
Supply Voltage (VDD) Section							
I startup	Startup Current	VDD=UVLO_OFF-1V		4	20	uA	
DD op	Operation Current	Operation supply current FB=1V, CS=0V, VDD= 20V		0.45	1	mA	
UVLO(ON)	VDD Under Voltage Lockout Enter	VDD falling	7.3	8.3	9.3	V	
UVLO(OFF)	VDD Under Voltage Lockout Exit	VDD rising	15.5	16.5	17.5	V	
V <sub>DD</sub> _clamp	Maximum VDD operation voltage	I <sub>DD</sub> =20mA		25		V	
Current Sens	se Input Section				•		
TLEB	LEB time			500		ns	
Vth_oc	Over current threshold		492	500	508	mV	
Td_oc	OCP Propagation delay			100		ns	
Frequency S	ection		•				
Freq_Max <sup>Note</sup>	IC Maximum frequency		103			KHz	
Toff_min	Minimum Toff			4.0		us	
F_min	Minimum frequency			103		Hz	
Error Amplifi	ier section		•				
Vref_EA	Reference voltage for EA		1.14	1.2	1.26	V	
Gain	DC gain of EA			40			
Vth_OVP	Load OVP threshold voltage			1.4		V	
On chip Ove	On chip Over temperature Section						
T_otp	latched over temperature protection trigger point			155		°C	

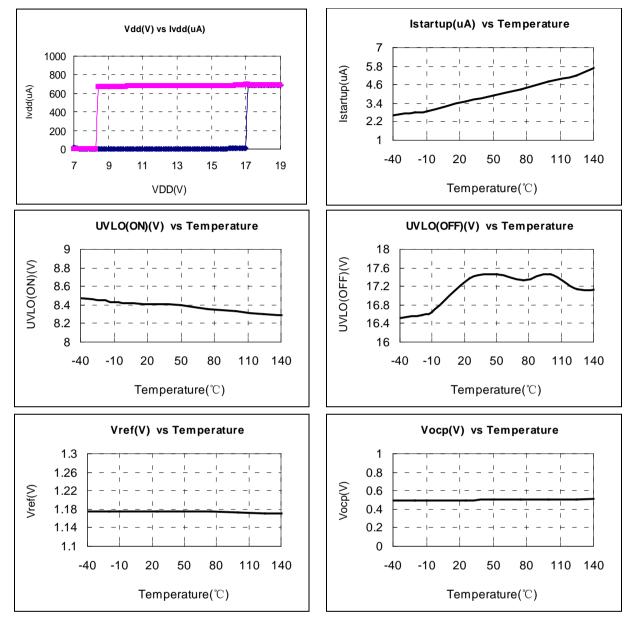
Parameter	BVdss(V) MOSFET Drain-Source Breakdown Voltage		
	Min	Тур.	Max
OB3398ENJP	600		
OB3398EPJP-H	650		
OB3398ETJP-H	650		
OB3398EPAP-H	650		
OB3398ETAP-H	650		
OB3398EVAP-H	650		

Note:

Freq\_Max indicates IC internal maximum clock frequency. In system application, the maximum operation frequency of 103KHz nominal occurs at maximum output power or the transition point from CV to CC.



# **CHARACTERIZATION PLOTS**





## **OPERATION DESCRIPTION**

OB3398Ex is a cost effective PWM power switch optimized for off-line LED lighting applications. Based on floating flyback converter topology working in DCM mode, it operates in primary side sensing and regulation, thus opto-coupler and TL431 are not required. Proprietary built-in CC control can achieve high precision LED current meeting LED lighting application requirements.

### Startup Current and Start up Control

Startup current of OB3398Ex is designed to be very low so that VDD could be charged up above UVLO threshold and starts up quickly. A large value startup resistor can therefore be used to minimize the power loss in application.

#### **Operating Current**

The Operating current of OB3398Ex is as low as 0.45mA(Typ.). Typical good efficiency is achieved with the low operating current together with 'Multi-mode' control features.

### **Principle of CC Operation**

To support OB3398Ex proprietary CC control, system needs to be designed in DCM mode for flyback system (Refer to Typical Application Diagram on page1). The LED output current  $I_{1 ED}$  is given by:

$$I_{LED} = \frac{1}{2} L_P \cdot F_{SW} \cdot I_{PK}^2 \cdot \eta / V_O \tag{1}$$

Where Lp indicates the inductance of primary winding, lpk is the peak current of primary winding.

Refer to the equation 1, the change of the primary winding inductance results in the change of the constant output current. To compensate the change from variations of primary winding inductance, the switching frequency is locked by an internal loop such that the switching frequency is

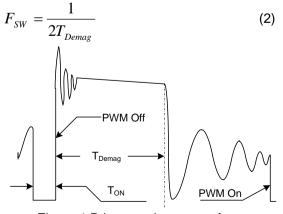


Figure.1 Primary voltage waveform

Since  $T_{Demag}$  is inversely proportional to the inductance, as a result, the product *Lp* and *fsw* is constant, thus output current will not change as primary winding inductance changes. Up to  $\pm 7\%$  variation of the primary winding inductance can be compensated.

The output LED current is

$$I_{LED} = \frac{1}{4} \cdot N \cdot \frac{V_{th_oc}}{R_s}$$
(3)

Where N is the ratio of transformer between primary winding and secondary winding.

### Adjustable CC point and Output Power

In OB3398Ex, the CC point and maximum output power can be externally adjusted by external current sense resistor Rs at CS pin as illustrated in Typical Application Diagram. The output power is adjusted through CC point change. The larger Rs, the smaller CC point is, and the smaller output power becomes, and vice versa as shown in Fig.2.

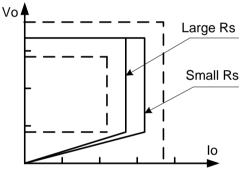


Figure.2 Adjustable output power by changing Rs

### **Operation switching frequency**

The switching frequency of OB3398Ex is adaptively controlled according to the load conditions and the operation modes. No external frequency setting components are required. The operation switching frequency at maximum output power is set to 103K Hz internally.

For flyback operating in DCM, The maximum output power is given by

$$P_{O\max} = \frac{1}{2} \eta L_{P} F_{SW} I_{pk}^{2}$$
 (4)

Where Lp indicate the inductance of primary winding and lpk is the peak current of primary winding.

The principle of CC operation sets the product Lp and fsw to be a constant, thus the maximum output power and constant current in CC mode will not change as primary winding inductance changes. Up to +/-7% variation of the primary winding inductance can be compensated.



### CV / OVP Mode

When LED string is open, an output voltage condition is monitored independently by the voltage at FB pin. During normal operation, the voltage at FB pin is regulated at 1.2V (typ.), with dummy load over Pmin.

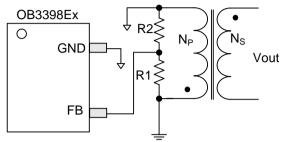


Figure.3 FB Section Circuit

$$V_{OUT} = \frac{N_s}{N_p} \times \frac{R1 + R2}{R2} \times V_{ref_CV}$$

R1 —Resistor connected between the FB pin and the input capacitor GND, the value suggested is 330Kohms~1Mohms

R2 —Resistor connected between the FB pin and the GND pin of IC, the value suggested is 5Kohms~15Kohms

$$P_{\min} = \frac{1}{2} \times \left(\frac{Vth_oc}{R_{CS}}\right)^2 F_{\min} L_{priamry}$$

 $V_{\text{th\_oc}}$  — Over current protection threshold voltage

 $F_{min}$  — Minimum switching frequency, which is 103Hz (typ.)

If the dummy load is less than  $P_{min}$ , the output voltage rises up. If the voltage at FB pin exceeds a threshold of approximately 1.4V (typical), the over-voltage protection function is activated and the switching is turned off immediately.

$$V_{OVP} = \frac{N_s}{N_p} \times \frac{R1 + R2}{R2} \times V_{vth_OVP}$$

### CC Line Regulation

Adjust the R1 for better CC line regulation, while driving different type MOSFET. The larger MOSFET, the smaller R1 needed. R1 allow the change from 330K to 1M ohms to cover all the applications. If the resistance is too large, it causes the interference due to the floating ground, too small resistance results the efficiency decreased at HV AC line.

### **Current Sensing and Leading Edge Blanking**

Cycle-by-Cycle current limiting is offered in OB3398Ex. The switch current is detected by a sense resistor into the CS pin. An internal leading edge blanking circuit chops off the sensed voltage spike at initial power MOSFET. The PWM duty cycle is determined by the current sense input voltage and the EA output voltage.

### Protection Control

Good power supply system reliability is achieved with its rich protection features including Cycle-by-Cycle current limiting (OCP), VDD clamp, on-chip OTP, and Under Voltage Lockout on VDD (UVLO).

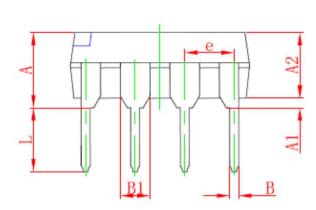
Over temperature protection is offered in OB3398Ex. When temperature of the device rises over  $155^{\circ}$  (typical), the switching frequency will decrease to half. And the state will be kept until the device restarts.

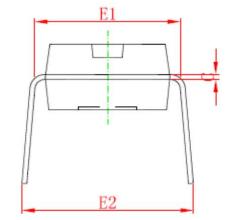
VDD is supplied by transformer primary winding output. The output of OB3398Ex is shut down when VDD drops below UVLO (ON) limit and the power converter enters power on start-up sequence thereafter.

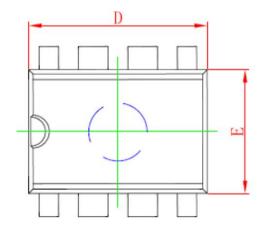


# PACKAGE MECHANICAL DATA

# **DIP8 PACKAGE OUTLINE DIMENSIONS**



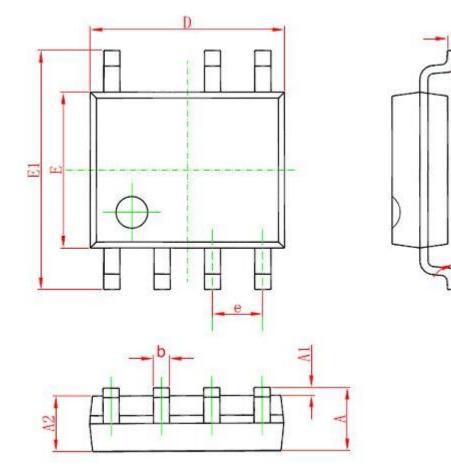




Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	3.710	5.334	0.146	0.210	
A1	0.381		0.015		
A2	2.921	4.953	0.115	0.195	
В	0.350	0.650	0.014	0.026	
B1	1.524 (BSC)		0.06 (BSC)		
С	0.200	0.360	0.008	0.014	
D	9.000	10.160	0.354	0.400	
E	6.096	7.112	0.240	0.280	
E1	7.320	8.255	0.288	0.325	
е	2.540 (BSC)		0.1 (I	BSC)	
L	2.921	3.810	0.115	0.150	
E2	7.620	10.920	0.300	0.430	



# SOP7 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1.350	1.750	0.053	0.069	
A1	0.050	0.250	0.002	0.010	
A2	1.250	1.650	0.049	0.065	
b	0.310	0.510	0.012	0.020	
С	0.100	0.250	0.004	0.010	
D	4.700	5.150	0.185	0.203	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270 (BSC)		0.050	(BSC)	
L	0.400	1.270	0.016	0.050	
θ	0°	8º	0°	8°	

θ



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